

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

[IXYS Corporation](#)
[VHFD29-14IO1](#)

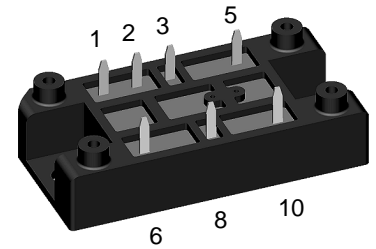
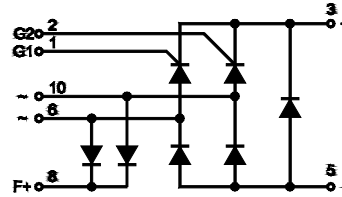
For any questions, you can email us directly:
sales@integrated-circuit.com

IXYS **VHFD 29**

**Half Controlled
 Single Phase Rectifier Bridge**
 Including Freewheeling Diode and Field Diodes

V_{RRM} = 800-1600 V
I_{dAVM} = 32 A

V _{RSM} V _{DSM} V	V _{RRM} V _{DRM} V	Type
900	800	VHFD 29-08io1
1300	1200	VHFD 29-12io1
1500	1400	VHFD 29-14io1
1700	1600	VHFD 29-16io1



Bridge and Freewheeling Diode

Symbol	Test Conditions	Maximum Ratings	
I _{dAV}	T _H = 85°C, module	28	A
I _{dAVM} ①	module	32	A
I _{FRMS} , I _{TRMS}	per leg	25	A
I _{FSM} , I _{TSM}	T _{VJ} = 45°C; V _R = 0 V	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	300 A 330 A
	T _{VJ} = T _{VJM} V _R = 0 V	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	270 A 300 A
I ² t	T _{VJ} = 45°C V _R = 0 V	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	440 A ² s 455 A ² s
	T _{VJ} = T _{VJM} V _R = 0 V	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine	365 A ² s 370 A ² s
(di/dt) _{cr}	T _{VJ} = 125°C f = 50 Hz, t _p = 200 μs V _D = 2/3 V _{DRM} I _G = 0.3 A, di _G /dt = 0.3 A/μs	repetitive, I _T = 50 A non repetitive, I _T = 0.5 I _{dAV}	150 A/μs 500 A/μs
(dv/dt) _{cr}	T _{VJ} = T _{(VJ)m} ; V _{DR} = 2/3 V _{DRM} R _{GK} = ∞; method 1 (linear voltage rise)		1000 V/μs
V _{RGM}			10 V
P _{GM}	T _{VJ} = T _{VJM} I _T = 0.5 I _{dAVM}	t _p = 30 μs	≤ 10 W
		t _p = 500 μs	≤ 5 W
		t _p = 10 ms	≤ 1 W
P _{GAVM}			0.5 W
T _{VJ}		-40...+125	°C
T _{VJM}		125	°C
T _{stg}		-40...+125	°C
V _{ISOL}	50/60 Hz, RMS I _{ISOL} ≤ 1 mA	t = 1 min	3000 V~
		t = 1 s	3600 V~
d _s	Creep distance on surface	12.7	mm
d _A	Strike distance in air	9.4	mm
a	Max. allowable acceleration	50	m/s ²
M _d	Mounting torque (M5) (10-32 UNF)		2-2.5 Nm
			18-22 lb.in.
Weight		35	g

Features

- Package with DCB ceramic base plate
- Isolation voltage 3600 V~
- Planar passivated chips
- Blocking voltage up to 1600 V
- Low forward voltage drop
- Leads suitable for PC board soldering
- UL registered E 72873

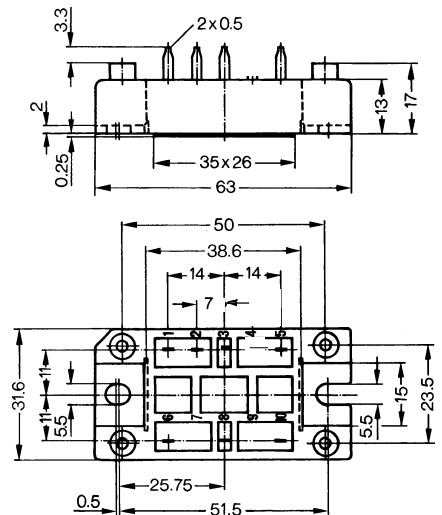
Applications

- Supply for DC power equipment
- DC motor control

Advantages

- Easy to mount with two screws
- Space and weight savings
- Improved temperature and power cycling

Dimensions in mm (1 mm = 0.0394")



IXYS VHFD 29

Symbol	Test Conditions	Characteristic Values
I_R, I_D	$V_R = V_{RRM}; V_D = V_{DRM}$ $T_{VJ} = T_{VJM}$ $T_{VJ} = 25^\circ\text{C}$	≤ 5 mA
		≤ 0.3 mA
V_T, V_F	$I_T, I_F = 45$ A; $T_{VJ} = 25^\circ\text{C}$	≤ 1.6 V
V_{T0}	For power-loss calculations only ($T_{VJ} = 125^\circ\text{C}$)	0.9 V
r_T		15 m Ω
V_{GT}	$V_D = 6$ V; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$	≤ 1.0 V
		≤ 1.2 V
I_{GT}	$V_D = 6$ V; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	≤ 65 mA
		≤ 80 mA
		≤ 50 mA
		≤ 50 mA
V_{GD}	$T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$	≤ 0.2 V
I_{GD}	$T_{VJ} = T_{VJM}; V_D = 2/3 V_{DRM}$	≤ 5 mA
I_L	$I_G = 0.3$ A; $t_g = 30$ μs ; $di_G/dt = 0.3$ A/ μs ; $T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = -40^\circ\text{C}$ $T_{VJ} = 125^\circ\text{C}$	≤ 150 mA
		≤ 200 mA
		≤ 100 mA
I_H	$T_{VJ} = 25^\circ\text{C}; V_D = 6$ V; $R_{GK} = \infty$	≤ 100 mA
t_{gd}	$T_{VJ} = 25^\circ\text{C}; V_D = 0.5V_{DRM}$ $I_G = 0.3$ A; $di_G/dt = 0.3$ A/ μs	≤ 2 μs
t_q	$T_{VJ} = 125^\circ\text{C}; I_T = 15$ A; $t_p = 300$ μs ; $V_R = 100$ V	typ. 150 μs
Q_r	$di/dt = -10$ A/ μs ; $dv/dt = 20$ V/ μs ; $V_D = 2/3 V_{DRM}$	75 μC
R_{thJC}	per thyristor (diode); DC current	1.4 K/W
	per module	0.35 K/W
R_{thJH}	per thyristor (diode); DC current	2.0 K/W
	per module	0.5 K/W

Field Diodes

Symbol	Test Conditions	Maximum Ratings
I_{FAV}	$T_H = 85^\circ\text{C}$, per Diode	4 A
I_{FAVM}	per diode	4 A
I_{FRMS}	per diode	6 A
I_{FSM}	$T_{VJ} = 45^\circ\text{C}; V_R = 0$ V	$t = 10$ ms (50 Hz), sine: 100 A
		$t = 8.3$ ms (60 Hz), sine: 110 A
	$T_{VJ} = T_{VJM}; V_R = 0$ V	$t = 10$ ms (50 Hz), sine: 85 A
		$t = 8.3$ ms (60 Hz), sine: 94 A
I^2t	$T_{VJ} = 45^\circ\text{C}; V_R = 0$ V	$t = 10$ ms (50 Hz), sine: 50 A ² s
		$t = 8.3$ ms (60 Hz), sine: 50 A ² s
	$T_{VJ} = T_{VJM}; V_R = 0$ V	$t = 10$ ms (50 Hz), sine: 36 A ² s
		$t = 8.3$ ms (60 Hz), sine: 37 A ² s
I_R	$V_R = V_{RRM}; T_{VJ} = T_{VJM}; T_{VJ} = 25^\circ\text{C}$	1 mA
		0.15 mA
V_F	$I_F = 21$ A; $T_{VJ} = 25^\circ\text{C}$	1.83 V
V_{T0}	For power-loss calculations only ($T_{VJ} = 125^\circ\text{C}$)	0.9 V
r_T		50 m Ω
R_{thJC}	per diode; DC current	4.4 K/W
R_{thJH}	per diode; DC current	5.2 K/W

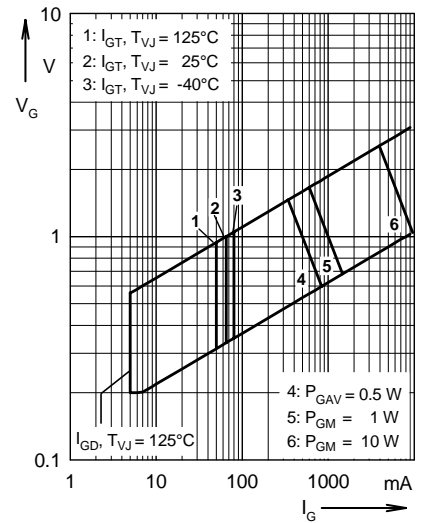


Fig. 1 Gate trigger range

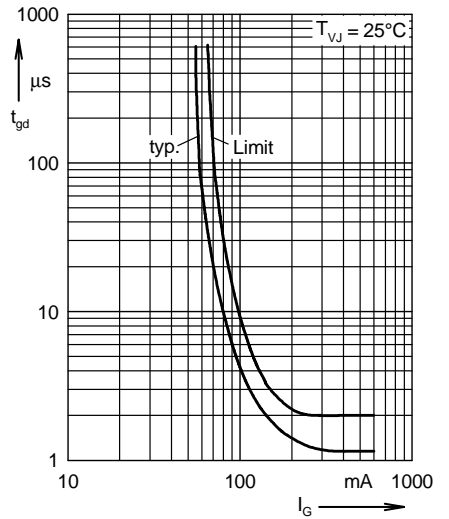


Fig. 2 Gate controlled delay time t_{gd}

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.

① for resistive load

IXYS reserves the right to change limits, test conditions and dimensions.

IXYS **VHFD 29**

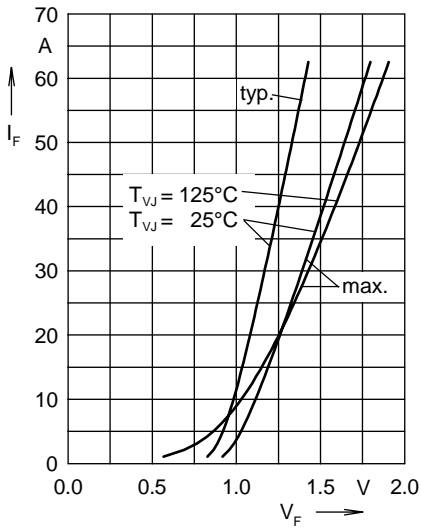


Fig. 3 Forward current versus voltage drop per diode

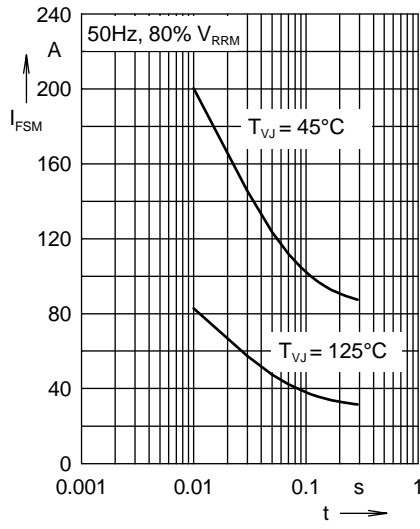


Fig. 4 Surge overload current

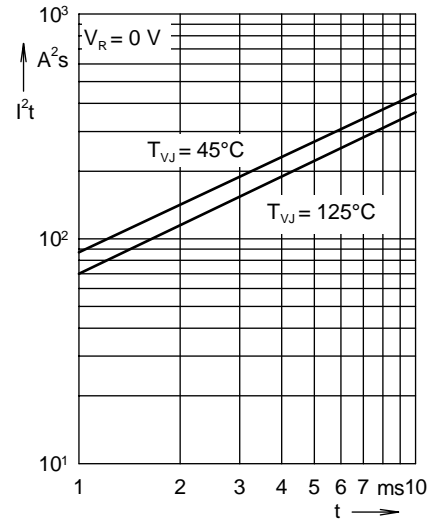


Fig. 5 I²t versus time per diode

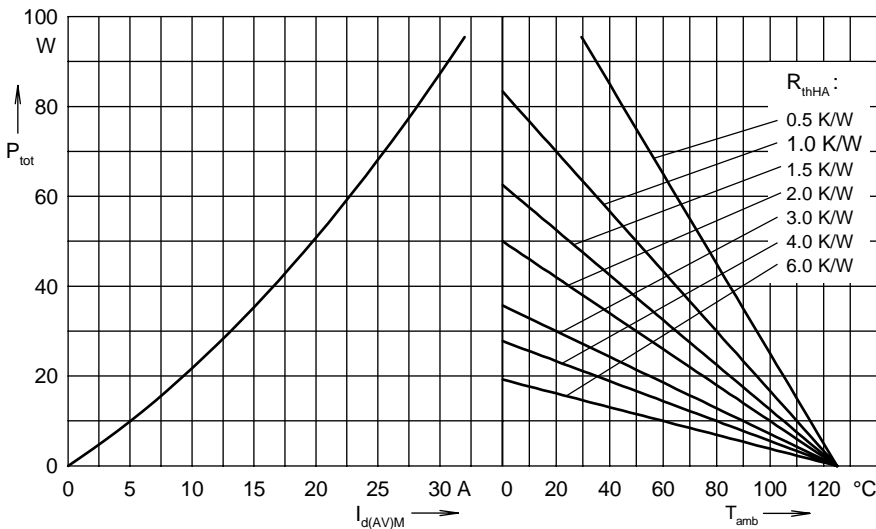


Fig. 6 Power dissipation versus direct output current and ambient temperature

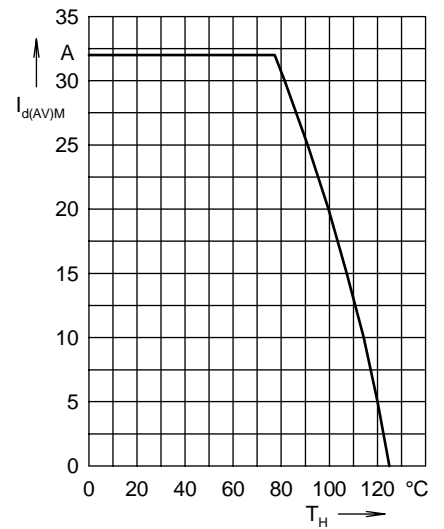


Fig. 7 Max. forward current versus heatsink temperature

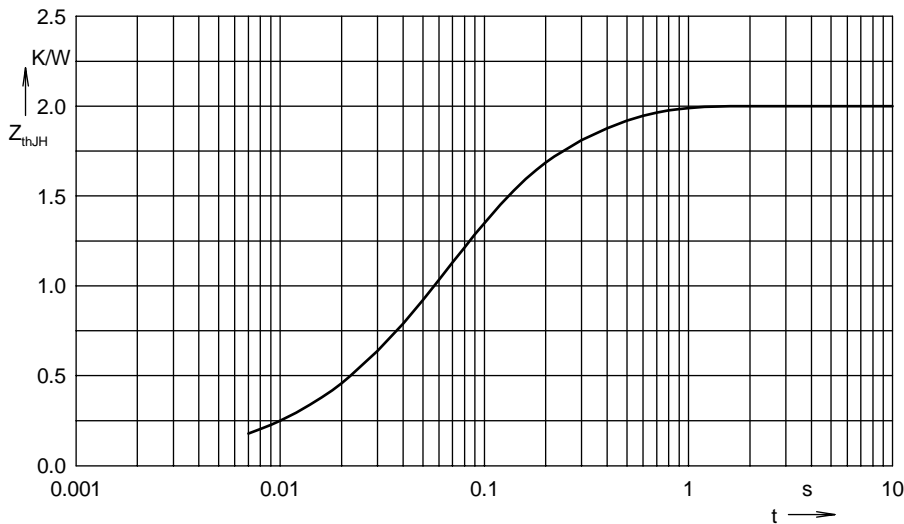


Fig. 8 Transient thermal impedance junction to heatsink

Constants for Z_{thJH} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.007	0.008
2	0.266	0.05
3	1.127	0.06
4	0.6	0.25